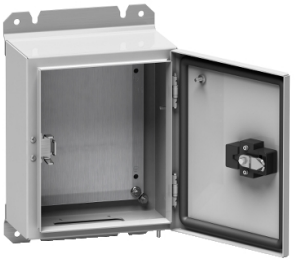
Product data sheet

Specifications



PanelSeT S3D seismic plain door with mount.plate - H700xW500xD250 - IP65 - IK10

NSYS3D6G7525P

Main

Range	PanelSeT
Product name	S3D 6G
Enclosure application	Seismic
Product or component type	Enclosure
Enclosure nominal height	700 mm
Enclosure nominal width	500 mm
Enclosure nominal depth	250 mm
Door type	Plain
Mounting plate description	Reinforce
Enclosure mounting	Wall mounted
Device composition	1 x body 1 x door 1 x lock 2 x fixing bracket 1 x mounting plate 1 x earthing components door and lock 1 x cable gland plate
Continuity of earth	Earthing connection between body and door

Complementary

Body type	Single piece body Gutter-shaped front rail
Number of doors	Front face: 1 door(s)
Door opening side	Right (120 °)
Lock type	3-point closure
Type of keylock	405E
Type of operating handle	Swing handle
Accessibility for operation	Front
Removable parts	Cable gland plate by screws
Material	Steel
Thickness	Body: 2 mm Door: 2 mm Cable gland plate: 1.5 mm
Surface finish	Epoxy-polyester powder
Colour	Grey (RAL 7035)
Net weight	33 kg

Disclaimer: This documentation is not intended as a substitute for and is not to be used for determining suitability or reliability of these products for specific user applications

Environment

Surface treatment	87 % decontaminable painting conforming to NF T 30-501.
Standards	IEC 62208 EDF CRT 91 C 112 00
IP degree of protection	IP65 conforming to IEC 60529
IK degree of protection	IK10 conforming to IEC 62262
Seismic performance	Seismic tests 6G conforming to EDF CRT 91 C 112 00

Packing Units

Unit Type of Package 1	PCE
Number of Units in Package 1	1
Package 1 Height	30.000 cm
Package 1 Width	53.000 cm
Package 1 Length	78.000 cm
Package 1 Weight	34.000 kg
Unit Type of Package 2	PAM
Number of Units in Package 2	5
Package 2 Height	98.000 cm
Package 2 Width	100.000 cm
Package 2 Length	120.000 cm
Package 2 Weight	182.000 kg

Contractual warranty

Warranty (in months)	18

Environmental Data

Schneider Electric aims to achieve Net Zero status by 2050 through supply chain partnerships, lower impact materials, and circularity via our ongoing “Use Better, Use Longer, Use Again” campaign to extend product lifetimes and recyclability.

Environmental Data explained >

How we assess product sustainability >

Environmental footprint

Total lifecycle Carbon footprint	**320 kg CO2 eq.**
Carbon footprint of the manufacturing phase [A1 to A3]	**166 kg CO2 eq.**
Carbon footprint of the distribution phase [A4]	**68 kg CO2 eq.**
Carbon footprint of the installation phase [A5]	**7 kg CO2 eq.**
Carbon footprint of the use phase [B2, B3, B4, B6]	**0 kg CO2 eq.**
Carbon footprint of the end-of-life phase [C1 to C4]	**80 kg CO2 eq.**

Use Better

Materials and Substances

Packaging made with recycled cardboard	**No**
Packaging without single use plastic	**No**
SCIP Number	**E893f0a0-d2cc-4011-9425-3873dde70142**
EU RoHS Directive	**Compliant**
REACh Regulation	**Free of Substances of Very High Concern above the threshold**

Use Again

Repack and remanufacture

Take-back	**No**